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### **Embedded - System On Chip (SoC): The Heart of Modern Embedded Systems**

**Embedded - System On Chip (SoC)** refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

### **What are Embedded - System On Chip (SoC)?**

**System On Chip (SoC)** integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions, SoCs combine a central

#### **Details**

Product Status	Active
Architecture	MCU, FPGA
Core Processor	Dual ARM® Cortex®-A9 MPCore™ with CoreSight™
Flash Size	-
RAM Size	64KB
Peripherals	DMA, POR, WDT
Connectivity	CANbus, EBI/EMI, Ethernet, I <sup>2</sup> C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	800MHz
Primary Attributes	FPGA - 85K Logic Elements
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	672-FBGA
Supplier Device Package	672-UBGA (23x23)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/5csxfc5c6u23i7n">https://www.e-xfl.com/product-detail/intel/5csxfc5c6u23i7n</a>



**Table 2. Absolute Maximum Ratings for Cyclone V Devices**

Symbol	Description	Minimum	Maximum	Unit
V <sub>CC</sub>	Core voltage and periphery circuitry power supply	-0.5	1.43	V
V <sub>CCPGM</sub>	Configuration pins power supply	-0.5	3.90	V
V <sub>CC_AUX</sub>	Auxiliary supply	-0.5	3.25	V
V <sub>CCBAT</sub>	Battery back-up power supply for design security volatile key register	-0.5	3.90	V
V <sub>CCPD</sub>	I/O pre-driver power supply	-0.5	3.90	V
V <sub>CCIO</sub>	I/O power supply	-0.5	3.90	V
V <sub>CCA_FPLL</sub>	Phase-locked loop (PLL) analog power supply	-0.5	3.25	V
V <sub>CCH_GXB</sub>	Transceiver high voltage power	-0.5	3.25	V
V <sub>CCE_GXB</sub>	Transceiver power	-0.5	1.50	V
V <sub>CCL_GXB</sub>	Transceiver clock network power	-0.5	1.50	V
V <sub>I</sub>	DC input voltage	-0.5	3.80	V
V <sub>CC_HPS</sub>	HPS core voltage and periphery circuitry power supply	-0.5	1.43	V
V <sub>CCPD_HPS</sub>	HPS I/O pre-driver power supply	-0.5	3.90	V
V <sub>CCIO_HPS</sub>	HPS I/O power supply	-0.5	3.90	V
V <sub>CCRSTCLK_HPS</sub>	HPS reset and clock input pins power supply	-0.5	3.90	V
V <sub>CCPLL_HPS</sub>	HPS PLL analog power supply	-0.5	3.25	V
V <sub>CC_AUX_SHARED</sub> <sup>(1)</sup>	HPS auxiliary power supply	-0.5	3.25	V
I <sub>OUT</sub>	DC output current per pin	-25	40	mA
T <sub>J</sub>	Operating junction temperature	-55	125	°C
T <sub>STG</sub>	Storage temperature (no bias)	-65	150	°C

<sup>(1)</sup> V<sub>CC\_AUX\_SHARED</sub> must be powered by the same source as V<sub>CC\_AUX</sub> for Cyclone V SX C5, C6, D5, and D6 devices, and Cyclone V SE A5 and A6 devices.



### Maximum Allowed Overshoot and Undershoot Voltage

During transitions, input signals may overshoot to the voltage listed in the following table and undershoot to  $-2.0$  V for input currents less than 100 mA and periods shorter than 20 ns.

The maximum allowed overshoot duration is specified as a percentage of high time over the lifetime of the device. A DC signal is equivalent to 100% duty cycle.

For example, a signal that overshoots to 4.00 V can only be at 4.00 V for  $\sim 15\%$  over the lifetime of the device; for a device lifetime of 10 years, this amounts to 1.5 years.

**Table 3. Maximum Allowed Overshoot During Transitions for Cyclone V Devices**

This table lists the maximum allowed input overshoot voltage and the duration of the overshoot voltage as a percentage of device lifetime.

Symbol	Description	Condition (V)	Overshoot Duration as % of High Time	Unit
Vi (AC)	AC input voltage	3.8	100	%
		3.85	68	%
		3.9	45	%
		3.95	28	%
		4	15	%
		4.05	13	%
		4.1	11	%
		4.15	9	%
		4.2	8	%
		4.25	7	%
		4.3	5.4	%
		4.35	3.2	%
		4.4	1.9	%
		4.45	1.1	%

*continued...*



Symbol	Description	Condition	Minimum <sup>(11)</sup>	Typical	Maximum <sup>(11)</sup>	Unit
		1.8 V	1.71	1.8	1.89	V
V <sub>CCPLL_HPS</sub>	HPS PLL analog voltage regulator power supply	—	2.375	2.5	2.625	V
V <sub>CC_AUX_SHARED</sub> <sup>(14)</sup>	HPS auxiliary power supply	—	2.375	2.5	2.625	V

### Related Information

[Recommended Operating Conditions](#) on page 8

Provides the steady-state voltage values for the FPGA portion of the device.

## DC Characteristics

### Supply Current and Power Consumption

Intel offers two ways to estimate power for your design—the Excel-based EPE and the Intel® Quartus® Prime Power Analyzer feature.

Use the Excel-based EPE before you start your design to estimate the supply current for your design. The EPE provides a magnitude estimate of the device power because these currents vary greatly with the resources you use.

The Intel Quartus Prime Power Analyzer provides better quality estimates based on the specifics of the design after you complete place-and-route. The Power Analyzer can apply a combination of user-entered, simulation-derived, and estimated signal activities that, when combined with detailed circuit models, yields very accurate power estimates.

### Related Information

- [Early Power Estimator User Guide](#)  
Provides more information about power estimation tools.
- [Power Analysis chapter, Intel Quartus Prime Handbook](#)  
Provides more information about power estimation tools.

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<sup>(11)</sup> The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

<sup>(14)</sup> V<sub>CC\_AUX\_SHARED</sub> must be powered by the same source as V<sub>CC\_AUX</sub> for Cyclone V SX C5, C6, D5, and D6 devices, and Cyclone V SE A5 and A6 devices.



I/O Standard	V <sub>CCIO</sub> (V)			V <sub>REF</sub> (V)			V <sub>TT</sub> (V)		
	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max
SSTL-15 Class I, II	1.425	1.5	1.575	$0.49 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$0.51 \times V_{CCIO}$	$0.49 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$0.51 \times V_{CCIO}$
SSTL-135 Class I, II	1.283	1.35	1.418	$0.49 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$0.51 \times V_{CCIO}$	$0.49 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$0.51 \times V_{CCIO}$
SSTL-125 Class I, II	1.19	1.25	1.26	$0.49 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$0.51 \times V_{CCIO}$	$0.49 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$0.51 \times V_{CCIO}$
HSTL-18 Class I, II	1.71	1.8	1.89	0.85	0.9	0.95	—	$V_{CCIO}/2$	—
HSTL-15 Class I, II	1.425	1.5	1.575	0.68	0.75	0.9	—	$V_{CCIO}/2$	—
HSTL-12 Class I, II	1.14	1.2	1.26	$0.47 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$0.53 \times V_{CCIO}$	—	$V_{CCIO}/2$	—
HSUL-12	1.14	1.2	1.3	$0.49 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$0.51 \times V_{CCIO}$	—	—	—

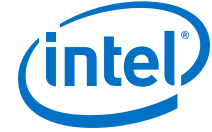
### Single-Ended SSTL, HSTL, and HSUL I/O Standards Signal Specifications

Table 17. Single-Ended SSTL, HSTL, and HSUL I/O Standards Signal Specifications for Cyclone V Devices

I/O Standard	V <sub>IL(DC)</sub> (V)		V <sub>IH(DC)</sub> (V)		V <sub>IL(AC)</sub> (V)	V <sub>IH(AC)</sub> (V)	V <sub>OL</sub> (V)	V <sub>OH</sub> (V)	I <sub>OL</sub> <sup>(19)</sup> (mA)	I <sub>OH</sub> <sup>(19)</sup> (mA)
	Min	Max	Min	Max	Max	Min	Max	Min		
SSTL-2 Class I	-0.3	V <sub>REF</sub> - 0.15	V <sub>REF</sub> + 0.15	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.31	V <sub>REF</sub> + 0.31	V <sub>TT</sub> - 0.608	V <sub>TT</sub> + 0.608	8.1	-8.1
SSTL-2 Class II	-0.3	V <sub>REF</sub> - 0.15	V <sub>REF</sub> + 0.15	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.31	V <sub>REF</sub> + 0.31	V <sub>TT</sub> - 0.81	V <sub>TT</sub> + 0.81	16.2	-16.2
SSTL-18 Class I	-0.3	V <sub>REF</sub> - 0.125	V <sub>REF</sub> + 0.125	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.25	V <sub>REF</sub> + 0.25	V <sub>TT</sub> - 0.603	V <sub>TT</sub> + 0.603	6.7	-6.7
SSTL-18 Class II	-0.3	V <sub>REF</sub> - 0.125	V <sub>REF</sub> + 0.125	V <sub>CCIO</sub> + 0.3	V <sub>REF</sub> - 0.25	V <sub>REF</sub> + 0.25	0.28	V <sub>CCIO</sub> - 0.28	13.4	-13.4

*continued...*

(19) To meet the I<sub>OL</sub> and I<sub>OH</sub> specifications, you must set the current strength settings accordingly. For example, to meet the SSTL15CI specification (8 mA), you should set the current strength settings to 8 mA. Setting at lower current strength may not meet the I<sub>OL</sub> and I<sub>OH</sub> specifications in the datasheet.



## Differential I/O Standard Specifications

**Table 20. Differential I/O Standard Specifications for Cyclone V Devices**

Differential inputs are powered by  $V_{CCPD}$  which requires 2.5 V.

I/O Standard	$V_{CCIO}$ (V)			$V_{ID}$ (mV) <sup>(21)</sup>			$V_{ICM(DC)}$ (V)			$V_{OD}$ (V) <sup>(22)</sup>			$V_{OCM}$ (V) <sup>(22)(23)</sup>		
	Min	Typ	Max	Min	Condition	Max	Min	Condition	Max	Min	Typ	Max	Min	Typ	Max
PCML	Transmitter, receiver, and input reference clock pins of high-speed transceivers use the PCML I/O standard. For transmitter, receiver, and reference clock I/O pin specifications, refer to <i>Transceiver Specifications for Cyclone V GX, GT, SX, and ST Devices</i> table.														
2.5 V LVDS <sup>(24)</sup>	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.05	$D_{MAX} \leq 700$ Mbps	1.80	0.247	—	0.6	1.125	1.25	1.375
							1.05	$D_{MAX} > 700$ Mbps	1.55						
BLVDS <sup>(25)(26)</sup>	2.375	2.5	2.625	100	—	—	—	—	—	—	—	—	—	—	—
RSDS (HIO) <sup>(27)</sup>	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.25	—	1.45	0.1	0.2	0.6	0.5	1.2	1.4
Mini-LVDS (HIO) (28)	2.375	2.5	2.625	200	—	600	0.300	—	1.425	0.25	—	0.6	1	1.2	1.4

*continued...*

(21) The minimum  $V_{ID}$  value is applicable over the entire common mode range,  $V_{CM}$ .

(22)  $R_L$  range:  $90 \leq R_L \leq 110 \Omega$ .

(23) This applies to default pre-emphasis setting only.

(24) For optimized LVDS receiver performance, the receiver voltage input range must be within 1.0 V to 1.6 V for data rate above 700 Mbps and 0.00 V to 1.85 V for data rate below 700 Mbps.

(25) There are no fixed  $V_{ICM}$ ,  $V_{OD}$ , and  $V_{OCM}$  specifications for BLVDS. They depend on the system topology.

(26) For more information about BLVDS interface support in Intel devices, refer to *AN522: Implementing Bus LVDS Interface in Supported Intel Device Families*.

(27) For optimized RSDS receiver performance, the receiver voltage input range must be within 0.25 V to 1.45 V.

(28) For optimized mini-LVDS receiver performance, the receiver voltage input range must be within 0.300 V to 1.425 V.



I/O Standard	V <sub>CCIO</sub> (V)			V <sub>ID</sub> (mV) <sup>(21)</sup>			V <sub>ICM(DC)</sub> (V)			V <sub>OD</sub> (V) <sup>(22)</sup>			V <sub>OCM</sub> (V) <sup>(22)(23)</sup>		
	Min	Typ	Max	Min	Condition	Max	Min	Condition	Max	Min	Typ	Max	Min	Typ	Max
LVPECL <sup>(29)</sup>	—	—	—	300	—	—	0.60	D <sub>MAX</sub> ≤ 700 Mbps	1.80	—	—	—	—	—	—
							1.00	D <sub>MAX</sub> > 700 Mbps	1.60						
SLVS	2.375	2.5	2.625	100	V <sub>CM</sub> = 1.25 V	—	0.05	—	1.80	—	—	—	—	—	—
Sub-LVDS	2.375	2.5	2.625	100	V <sub>CM</sub> = 1.25 V	—	0.05	—	1.80	—	—	—	—	—	—
HiSpi	2.375	2.5	2.625	100	V <sub>CM</sub> = 1.25 V	—	0.05	—	1.80	—	—	—	—	—	—

### Related Information

- [AN522: Implementing Bus LVDS Interface in Supported Intel Device Families](#)  
Provides more information about BLVDS interface support in Intel devices.
- [Transceiver Specifications for Cyclone V GX, GT, SX, and ST Devices](#) on page 25  
Provides the specifications for transmitter, receiver, and reference clock I/O pin.

## Switching Characteristics

This section provides performance characteristics of Cyclone V core and periphery blocks.

<sup>(21)</sup> The minimum V<sub>ID</sub> value is applicable over the entire common mode range, V<sub>CM</sub>.

<sup>(22)</sup> R<sub>L</sub> range: 90 ≤ R<sub>L</sub> ≤ 110 Ω.

<sup>(23)</sup> This applies to default pre-emphasis setting only.

<sup>(29)</sup> For optimized LVPECL receiver performance, the receiver voltage input range must be within 0.85 V to 1.75 V for data rate above 700 Mbps and 0.45 V to 1.95 V for data rate below 700 Mbps.



## Transceiver Performance Specifications

### Transceiver Specifications for Cyclone V GX, GT, SX, and ST Devices

**Table 21. Reference Clock Specifications for Cyclone V GX, GT, SX, and ST Devices**

Symbol/Description	Condition	Transceiver Speed Grade 5 <sup>(30)</sup>			Transceiver Speed Grade 6			Transceiver Speed Grade 7			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Supported I/O standards	1.2 V PCML, 1.5 V PCML, 2.5 V PCML, Differential LVPECL <sup>(31)</sup> , HCSSL, and LVDS										
Input frequency from REFCLK input pins <sup>(32)</sup>	—	27	—	550	27	—	550	27	—	550	MHz
Rise time	Measure at ±60 mV of differential signal <sup>(33)</sup>	—	—	400	—	—	400	—	—	400	ps
Fall time	Measure at ±60 mV of differential signal <sup>(33)</sup>	—	—	400	—	—	400	—	—	400	ps
Duty cycle	—	45	—	55	45	—	55	45	—	55	%
Peak-to-peak differential input voltage	—	200	—	2000	200	—	2000	200	—	2000	mV
Spread-spectrum modulating clock frequency	PCIe	30	—	33	30	—	33	30	—	33	kHz
Spread-spectrum downspread	PCIe	—	0 to -0.5%	—	—	0 to -0.5%	—	—	0 to -0.5%	—	—
On-chip termination resistors	—	—	100	—	—	100	—	—	100	—	Ω

*continued...*

- <sup>(30)</sup> Transceiver Speed Grade 5 covers specifications for Cyclone V GT and ST devices.
- <sup>(31)</sup> Differential LVPECL signal levels must comply to the minimum and maximum peak-to-peak differential input voltage specified in this table.
- <sup>(32)</sup> The reference clock frequency must be  $\geq 307.2$  MHz to be fully compliance to CPRI transmit jitter specification at 6.144 Gbps. For more information about CPRI 6.144 Gbps, refer to the *Transceiver Protocol Configurations in Cyclone V Devices* chapter.
- <sup>(33)</sup> REFCLK performance requires to meet transmitter REFCLK phase noise specification.





Symbol/Description	Condition	Transceiver Speed Grade 5 <sup>(30)</sup>			Transceiver Speed Grade 6			Transceiver Speed Grade 7			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Intra-differential pair skew	TX $V_{CM}$ = 0.65 V and slew rate of 15 ps	—	—	15	—	—	15	—	—	15	ps
Intra-transceiver block transmitter channel-to-channel skew	×6 PMA bonded mode	—	—	180	—	—	180	—	—	180	ps
Inter-transceiver block transmitter channel-to-channel skew	×N PMA bonded mode	—	—	500	—	—	500	—	—	500	ps

**Table 25. CMU PLL Specifications for Cyclone V GX, GT, SX, and ST Devices**

Symbol/Description	Condition	Transceiver Speed Grade 5 <sup>(30)</sup>			Transceiver Speed Grade 6			Transceiver Speed Grade 7			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Supported data range	—	614	—	5000/6144 <sup>(35)</sup>	614	—	3125	614	—	2500	Mbps
fPLL supported data range	—	614	—	3125	614	—	3125	614	—	2500	Mbps

**Table 26. Transceiver-FPGA Fabric Interface Specifications for Cyclone V GX, GT, SX, and ST Devices**

Symbol/Description	Condition	Transceiver Speed Grade 5 <sup>(30)</sup>			Transceiver Speed Grade 6			Transceiver Speed Grade 7			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Interface speed (single-width mode)	—	25	—	187.5	25	—	187.5	25	—	163.84	MHz
Interface speed (double-width mode)	—	25	—	163.84	25	—	163.84	25	—	156.25	MHz

**Related Information**

- [CTLE Response at Data Rates > 3.25 Gbps across Supported AC Gain and DC Gain](#) on page 32
- [CTLE Response at Data Rates ≤ 3.25 Gbps across Supported AC Gain and DC Gain](#) on page 33
- [PCIe Supported Configurations and Placement Guidelines](#)  
Provides more information about the maximum full duplex channels recommended in Cyclone V GT and ST devices which require full compliance to the PCIe Gen2 transmit jitter specification.



## Transceiver Compliance Specification

The following table lists the physical medium attachment (PMA) specification compliance of all supported protocol for Cyclone V GX, GT, SX, and ST devices. For more information about the protocol parameter details and compliance specifications, contact your Intel Sales Representative.

**Table 29. Transceiver Compliance Specification for All Supported Protocol for Cyclone V GX, GT, SX, and ST Devices**

Protocol	Sub-protocol	Data Rate (Mbps)
PCIe	PCIe Gen1	2,500
	PCIe Gen2 <sup>(50)</sup>	5,000
	PCIe Cable	2,500
XAUI	XAUI 2135	3,125
Serial RapidIO® (SRIO)	SRIO 1250 SR	1,250
	SRIO 1250 LR	1,250
	SRIO 2500 SR	2,500
	SRIO 2500 LR	2,500
	SRIO 3125 SR	3,125
	SRIO 3125 LR	3,125
	SRIO 5000 SR	5,000
	SRIO 5000 MR	5,000
	SRIO 5000 LR	5,000
Common Public Radio Interface (CPRI)	CPRI E6LV	614.4
	CPRI E6HV	614.4
	CPRI E6LVII	614.4

*continued...*

<sup>(50)</sup> For PCIe Gen2 sub-protocol, Intel recommends increasing the  $V_{CCE\_GXBL}$  and  $V_{CCL\_GXBL}$  typical value from 1.1 V to 1.2 V for Cyclone V GT and ST FPGA systems which ensure full compliance to the PCIe Gen2 transmit jitter specification. For more information about the maximum full duplex channels recommended in Cyclone V GT and ST devices under this condition, refer to the *Transceiver Protocol Configurations in Cyclone V Devices* chapter.



## Duty Cycle Distortion (DCD) Specifications

**Table 39. Worst-Case DCD on Cyclone V I/O Pins**

The output DCD cycle only applies to the I/O buffer. It does not cover the system DCD.

Symbol	-C6		-C7, -I7		-C8, -A7		Unit
	Min	Max	Min	Max	Min	Max	
Output Duty Cycle	45	55	45	55	45	55	%

## HPS Specifications

This section provides HPS specifications and timing for Cyclone V devices.

For HPS reset, the minimum reset pulse widths for the HPS cold and warm reset signals (HPS\_nRST and HPS\_nPOR) are six clock cycles of HPS\_CLK1.

## HPS Clock Performance

**Table 40. HPS Clock Performance for Cyclone V Devices**

Symbol/Description	-C6	-C7, -I7	-A7	-C8	Unit
mpu_base_clk (microprocessor unit clock)	925	800	700	600	MHz
main_base_clk (L3/L4 interconnect clock)	400	400	350	300	MHz
h2f_user0_clk	100	100	100	100	MHz
h2f_user1_clk	100	100	100	100	MHz
h2f_user2_clk	200	200	160	160	MHz



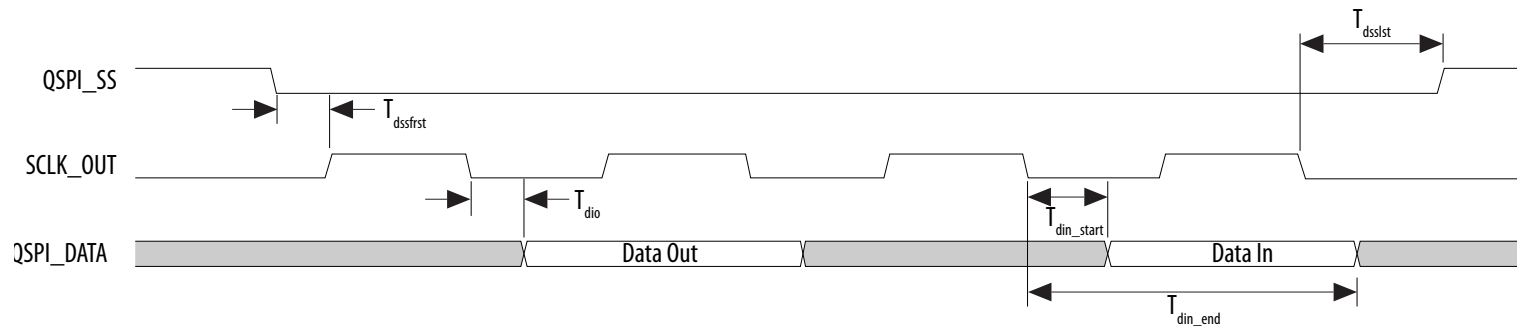
## Quad SPI Flash Timing Characteristics

**Table 43. Quad Serial Peripheral Interface (SPI) Flash Timing Requirements for Cyclone V Devices**

Symbol	Description	Min	Typ	Max	Unit
$F_{clk}$	SCLK_OUT clock frequency (External clock)	—	—	108	MHz
$T_{qspi\_clk}$	QSPI_CLK clock period (Internal reference clock)	2.32	—	—	ns
$T_{dutycycle}$	SCLK_OUT duty cycle	45	—	55	%
$T_{dssfrst}$	Output delay QSPI_SS valid before first clock edge	—	1/2 cycle of SCLK_OUT	—	ns
$T_{dsslst}$	Output delay QSPI_SS valid after last clock edge	-1	—	1	ns
$T_{dio}$	I/O data output delay	-1	—	1	ns
$T_{din\_start}$	Input data valid start	—	—	$(2 + R_{delay}) \times T_{qspi\_clk} - 7.52$ <sup>(68)</sup>	ns
$T_{din\_end}$	Input data valid end	$(2 + R_{delay}) \times T_{qspi\_clk} - 1.21$ <sup>(68)</sup>	—	—	ns

**Figure 6. Quad SPI Flash Timing Diagram**

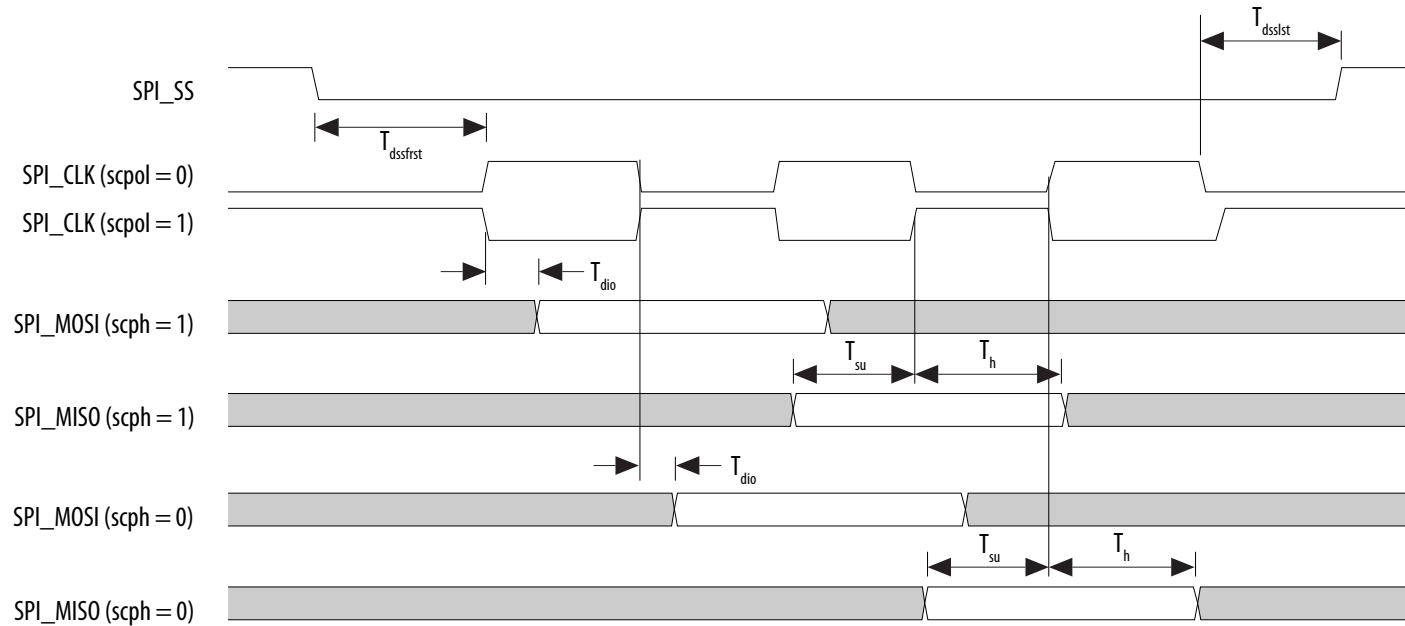
This timing diagram illustrates clock polarity mode 0 and clock phase mode 0.



<sup>(68)</sup>  $R_{delay}$  is set by programming the register `qspiregs.rddatacap`. For the SoC EDS software version 13.1 and later, Intel provides automatic Quad SPI calibration in the preloader. For more information about  $R_{delay}$ , refer to the *Quad SPI Flash Controller* chapter in the *Cyclone V Hard Processor System Technical Reference Manual*.



**Figure 7. SPI Master Timing Diagram**

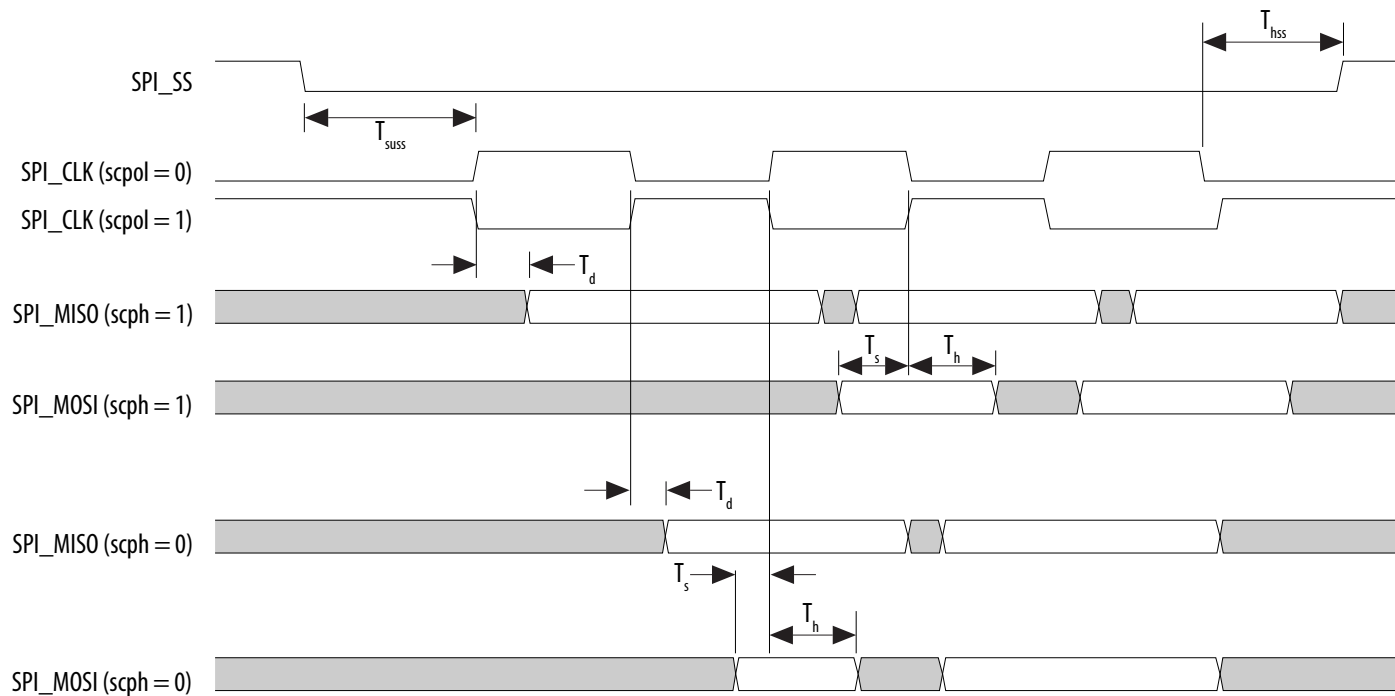


**Table 45. SPI Slave Timing Requirements for Cyclone V Devices**

The setup and hold times can be used for Texas Instruments SSP mode and National Semiconductor Microwire mode.

Symbol	Description	Min	Max	Unit
$T_{clk}$	CLK clock period	20	—	ns
$T_s$	MOSI Setup time	5	—	ns
$T_h$	MOSI Hold time	5	—	ns
$T_{suss}$	Setup time SPI_SS valid before first clock edge	8	—	ns
$T_{hss}$	Hold time SPI_SS valid after last clock edge	8	—	ns
$T_d$	MISO output delay	—	6	ns

**Figure 8. SPI Slave Timing Diagram**



**Related Information**

[SPI Controller, Cyclone V Hard Processor System Technical Reference Manual](#)

Provides more information about rx\_sample\_delay.



## SD/MMC Timing Characteristics

**Table 46. Secure Digital (SD)/MultiMediaCard (MMC) Timing Requirements for Cyclone V Devices**

After power up or cold reset, the Boot ROM uses  $drvsel = 3$  and  $smp1sel = 0$  to execute the code. At the same time, the SD/MMC controller enters the Identification Phase followed by the Data Phase. During this time, the value of interface output clock  $SDMMC\_CLK\_OUT$  changes from a maximum of 400 kHz (Identification Phase) up to a maximum of 12.5 MHz (Data Phase), depending on the internal reference clock  $SDMMC\_CLK$  and the  $CSEL$  setting. The value of  $SDMMC\_CLK$  is based on the external oscillator frequency and has a maximum value of 50 MHz.

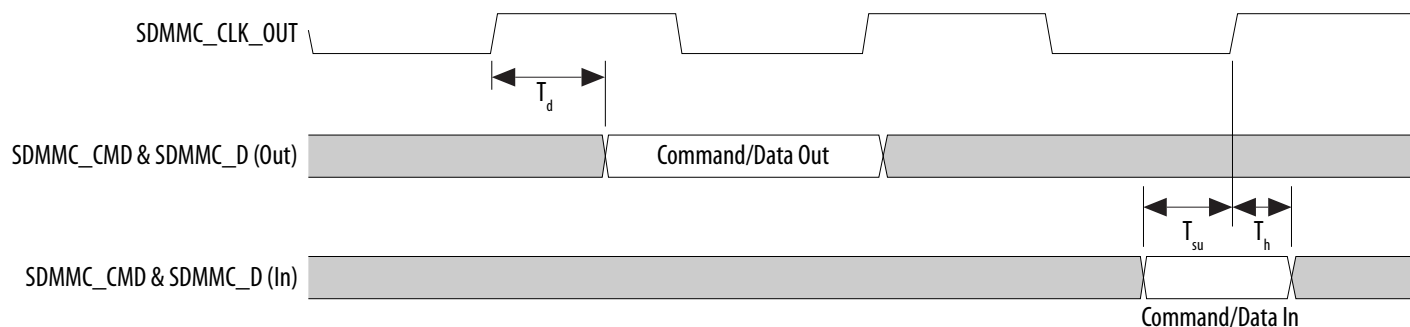
After the Boot ROM code exits and control is passed to the preloader, software can adjust the value of  $drvsel$  and  $smp1sel$  via the system manager.  $drvsel$  can be set from 1 to 7 and  $smp1sel$  can be set from 0 to 7. While the preloader is executing, the values for  $SDMMC\_CLK$  and  $SDMMC\_CLK\_OUT$  increase to a maximum of 200 MHz and 50 MHz respectively.

Symbol	Description	Min	Max	Unit
$T_{sdmmc\_clk}$ (internal reference clock)	SDMMC_CLK clock period (Identification mode)	20	—	ns
	SDMMC_CLK clock period (Default speed mode)	5	—	ns
	SDMMC_CLK clock period (High speed mode)	5	—	ns
$T_{sdmmc\_clk\_out}$ (interface output clock)	SDMMC_CLK_OUT clock period (Identification mode)	2500	—	ns
	SDMMC_CLK_OUT clock period (Default speed mode)	40	—	ns
	SDMMC_CLK_OUT clock period (High speed mode)	20	—	ns
$T_{duty}$	SDMMC_CLK_OUT duty cycle	45	55	%
$T_d$	SDMMC_CMD/SDMMC_D output delay	$(T_{sdmmc\_clk} \times drvsel)/2 - 1.23$ <sup>(70)</sup>	$(T_{sdmmc\_clk} \times drvsel)/2 + 1.69$ <sup>(70)</sup>	ns
$T_{su}$	Input setup time	$1.05 - (T_{sdmmc\_clk} \times smp1sel)/2$ <sup>(71)</sup>	—	ns
$T_h$	Input hold time	$(T_{sdmmc\_clk} \times smp1sel)/2$ <sup>(71)</sup>	—	ns

<sup>(70)</sup>  $drvsel$  is the drive clock phase shift select value.

<sup>(71)</sup>  $smp1sel$  is the sample clock phase shift select value.

**Figure 9. SD/MMC Timing Diagram**



**Related Information**

[Booting and Configuration Chapter, Cyclone V Hard Processor System Technical Reference Manual](#)

Provides more information about CSEL pin settings in the *SD/MMC Controller CSEL Pin Settings* table.

**USB Timing Characteristics**

PHYs that support LPM mode may not function properly with the USB controller due to a timing issue. It is recommended that designers use the MicroChip USB3300 PHY device that has been proven to be successful on the development board.

**Table 47. USB Timing Requirements for Cyclone V Devices**

Symbol	Description	Min	Typ	Max	Unit
$T_{clk}$	USB CLK clock period	—	16.67	—	ns
$T_d$	CLK to USB_STP/USB_DATA[7:0] output delay	4.4	—	11	ns
$T_{su}$	Setup time for USB_DIR/USB_NXT/USB_DATA[7:0]	2	—	—	ns
$T_h$	Hold time for USB_DIR/USB_NXT/USB_DATA[7:0]	1	—	—	ns



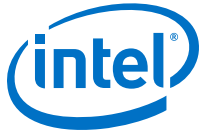
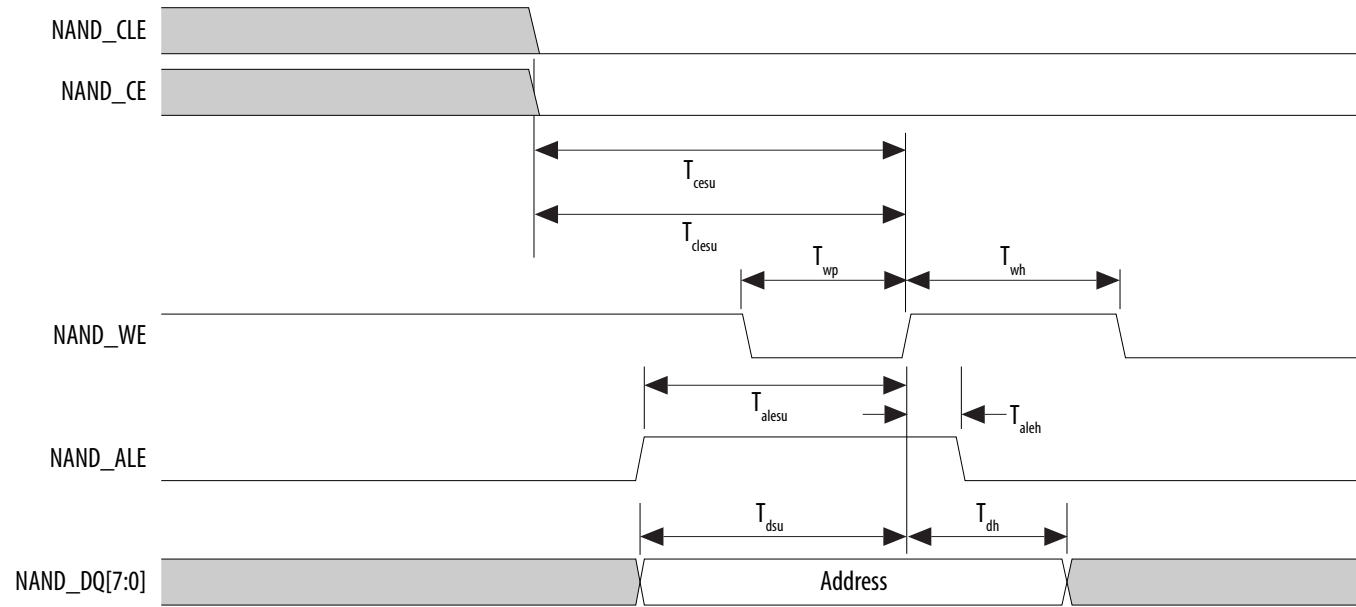


Figure 16. NAND Address Latch Timing Diagram





Symbol	Description	Min	Max	Unit
t <sub>JPCO</sub>	JTAG port clock to output	—	11 <sup>(76)</sup>	ns
t <sub>JPZX</sub>	JTAG port high impedance to valid output	—	14 <sup>(76)</sup>	ns
t <sub>JPXZ</sub>	JTAG port valid output to high impedance	—	14 <sup>(76)</sup>	ns

## FPP Configuration Timing

### DCLK-to-DATA[ ] Ratio (r) for FPP Configuration

Fast passive parallel (FPP) configuration requires a different DCLK-to-DATA[ ] ratio when you turn on encryption or the compression feature.

Depending on the DCLK-to-DATA[ ] ratio, the host must send a DCLK frequency that is  $r$  times the DATA[ ] rate in byte per second (Bps) or word per second (Wps). For example, in FPP  $\times 16$  where the  $r$  is 2, the DCLK frequency must be 2 times the DATA[ ] rate in Wps.

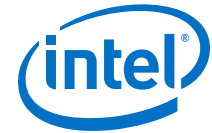
Cyclone V devices use additional clock cycles to decrypt and decompress the configuration data. If the DCLK-to-DATA[ ] ratio is greater than 1, at the end of configuration, you can only stop the DCLK (DCLK-to-DATA[ ] ratio - 1) clock cycles after the last data is latched into the Cyclone V device.

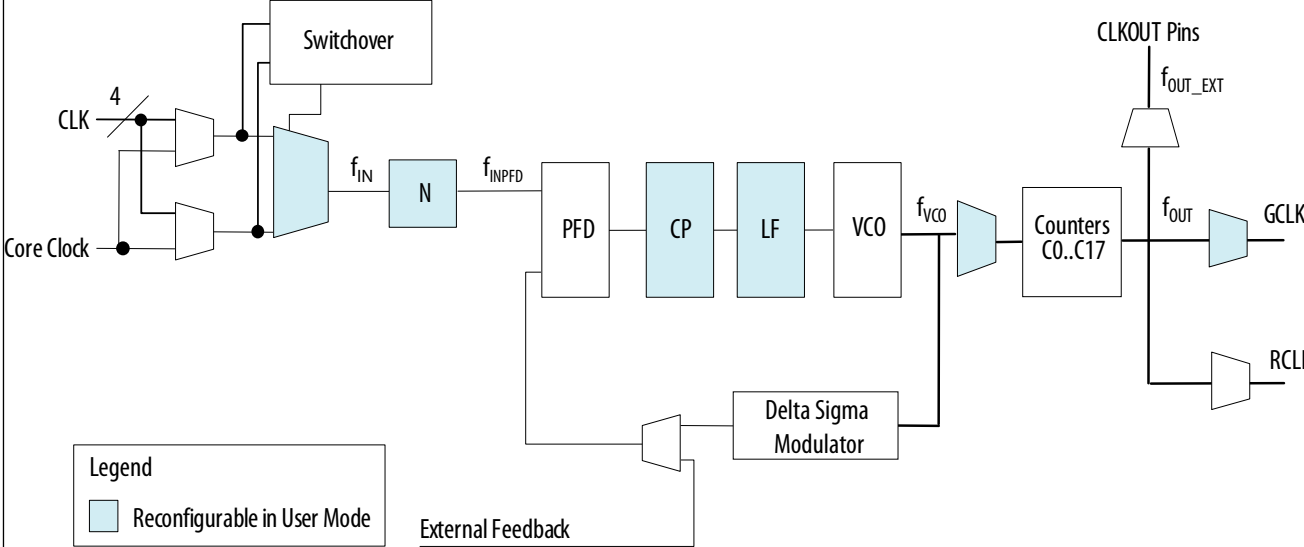
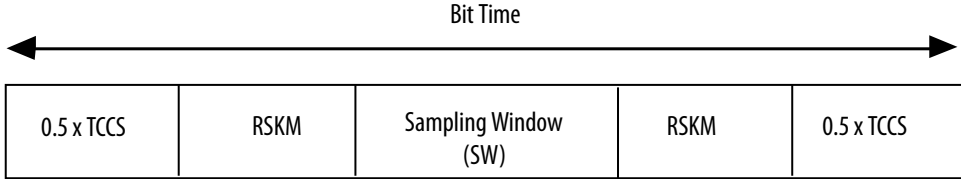
**Table 57. DCLK-to-DATA[ ] Ratio for Cyclone V Devices**

Configuration Scheme	Encryption	Compression	DCLK-to-DATA[ ] Ratio (r)
FPP (8-bit wide)	Off	Off	1
	On	Off	1
	Off	On	2
	On	On	2
FPP (16-bit wide)	Off	Off	1

*continued...*

<sup>(76)</sup> A 1-ns adder is required for each VCCIO voltage step down from 3.0 V. For example, t<sub>JPCO</sub> = 13 ns if VCCIO of the TDO I/O bank = 2.5 V, or 14 ns if it equals 1.8 V.



Term	Definition
	 <p>The diagram illustrates the PLL architecture. It starts with a 'Core Clock' input that branches into a '4' divider and a 'Switchover' block. The 'Switchover' block selects between the divided core clock and an external 'External Feedback' signal. The selected signal, labeled <math>f_{IN}</math>, passes through a divider 'N' to become <math>f_{INPFD}</math>. This signal then enters a series of blocks: PFD (Phase-Frequency Divider), CP (Charge Pump), LF (Loop Filter), and VCO (Voltage-Controlled Oscillator). The VCO output is <math>f_{VCO}</math>, which is divided by a 'Counters CO..C17' block to produce <math>f_{OUT}</math>. This output is then distributed to 'CLKOUT Pins' as <math>f_{OUT\_EXT}</math>, and also passes through a divider to become 'RCLK'. A 'Delta Sigma Modulator' block is connected to the feedback path between the PFD and the VCO input.</p> <p><b>Legend</b>  <span style="display: inline-block; width: 15px; height: 10px; background-color: #ADD8E6; border: 1px solid black; margin-right: 5px;"></span> Reconfigurable in User Mode</p> <p><b>Note:</b>              (1) Core Clock can only be fed by dedicated clock input pins or PLL outputs.</p>
R <sub>L</sub>	Receiver differential input discrete resistor (external to the Cyclone V device).
Sampling window (SW)	<p>Timing diagram—The period of time during which the data must be valid in order to capture it correctly. The setup and hold times determine the ideal strobe position in the sampling window, as shown:</p>  <p>The timing diagram shows a horizontal axis labeled 'Bit Time'. A double-headed arrow spans the width of the diagram. Below this, a sequence of five rectangular blocks is shown: '0.5 x TCCS', 'RSKM', 'Sampling Window (SW)', 'RSKM', and '0.5 x TCCS'. The 'Sampling Window (SW)' is the central block, and the 'RSKM' blocks are positioned on either side of it.</p>

continued...



Term	Definition
Single-ended voltage referenced I/O standard	<p>The JEDEC standard for the SSTL and HSTL I/O defines both the AC and DC input signal values. The AC values indicate the voltage levels at which the receiver must meet its timing specifications. The DC values indicate the voltage levels at which the final logic state of the receiver is unambiguously defined. After the receiver input has crossed the AC value, the receiver changes to the new logic state. The new logic state is then maintained as long as the input stays beyond the DC threshold. This approach is intended to provide predictable receiver timing in the presence of input waveform ringing.</p> <p>Single-Ended Voltage Referenced I/O Standard</p>
$t_c$	High-speed receiver/transmitter input and output clock period.
TCCS (channel-to-channel-skew)	The timing difference between the fastest and slowest output edges, including the $t_{CO}$ variation and clock skew, across channels driven by the same PLL. The clock is included in the TCCS measurement (refer to the Timing Diagram figure under SW in this table).
$t_{DUTY}$	High-speed I/O block—Duty cycle on high-speed transmitter output clock.
$t_{FALL}$	Signal high-to-low transition time (80–20%)
$t_{INCCJ}$	Cycle-to-cycle jitter tolerance on the PLL clock input
<i>continued...</i>	



Date	Version	Changes
February 2012	1.2	<ul style="list-style-type: none"><li>• Added automotive speed grade information.</li><li>• Added Figure 2-1.</li><li>• Updated Table 2-3, Table 2-8, Table 2-9, Table 2-19, Table 2-20, Table 2-21, Table 2-22, Table 2-23, Table 2-24, Table 2-25, Table 2-26, Table 2-27, Table 2-28, Table 2-30, Table 2-35, and Table 2-43.</li><li>• Minor text edits.</li></ul>
November 2011	1.1	<ul style="list-style-type: none"><li>• Added Table 2-5.</li><li>• Updated Table 2-3, Table 2-4, Table 2-11, Table 2-13, Table 2-20, and Table 2-21.</li></ul>
October 2011	1.0	Initial release.